## TOSHIBA

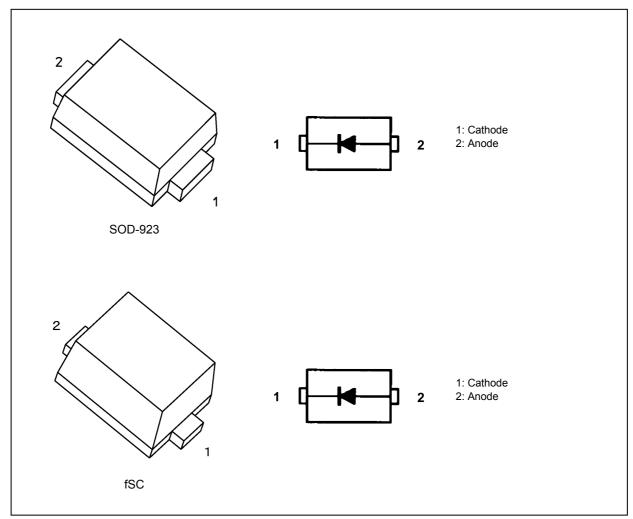
Switching Diodes Silicon Epitaxial Planar

# 1SS427

## 1. Applications

• Ultra-High-Speed Switching

## 2. Packaging and Internal Circuit



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## 3. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V <sub>RM</sub>		85	V
Reverse voltage	V <sub>R</sub>		80	
Peak forward current	I <sub>FM</sub>		200	mA
Average rectified current	I <sub>O</sub>		100	
Power dissipation	PD	(Note 1)	150	mW
Non-repetitive peak forward surge current	I <sub>FSM</sub>	(Note 2)	1	А
Junction temperature	Тј		150	°C
Storage temperature	T <sub>stg</sub>		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a glass epoxy circuit board of 20 mm  $\times$  20 mm, Pad dimension of 4 mm  $\times$  4 mm.

Note 2: Measured with a 10 ms pulse.

## 4. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V <sub>F(1)</sub>	I <sub>F</sub> = 1 mA	_	0.62	_	V
	V <sub>F(2)</sub>	I <sub>F</sub> = 10 mA	—	0.75	—	
	V <sub>F(3)</sub>	I <sub>F</sub> = 100 mA	—	0.98	1.20	
Reverse current	I <sub>R(1)</sub>	V <sub>R</sub> = 30 V	—	_	0.1	μA
	I <sub>R(2)</sub>	V <sub>R</sub> = 80 V	—	_	0.5	
Total capacitance	Ct	V <sub>R</sub> = 0 V, f = 1 MHz	_	0.3	_	pF
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 mA See Fig. 5.1.	—	1.6	—	ns

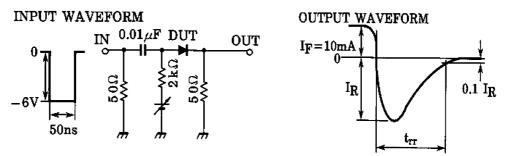
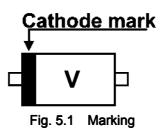


Fig. 4.1 Reverse recovery time (trr) Test circuit

5. Marking



6. Land Pattern Dimensions (for reference only)

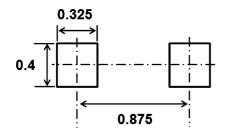


Fig. 6.1 SOD-923 (Unit: mm)

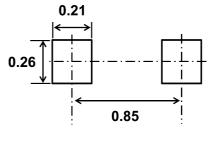
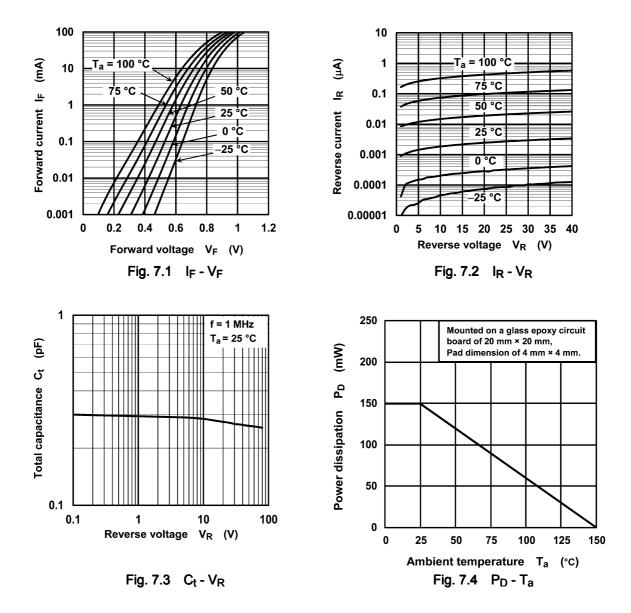


Fig. 6.2 fSC (Unit: mm)

## TOSHIBA

## 7. Characteristics Curves (Note)



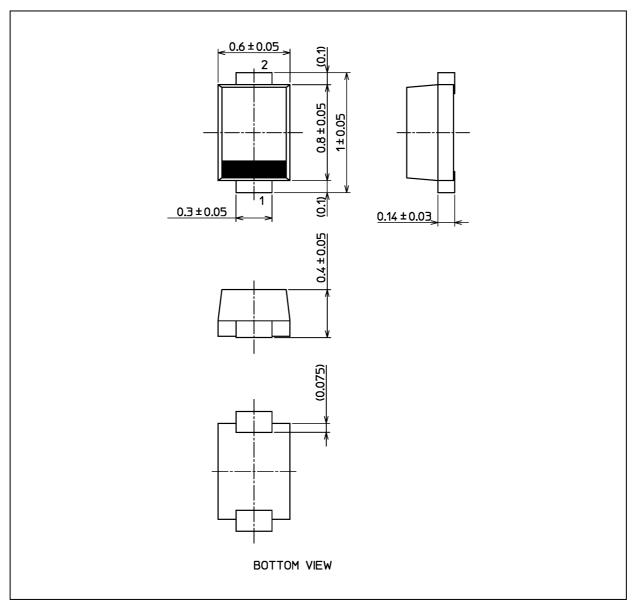
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## Package Dimensions

1SS427

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 0.55 mg (typ.)

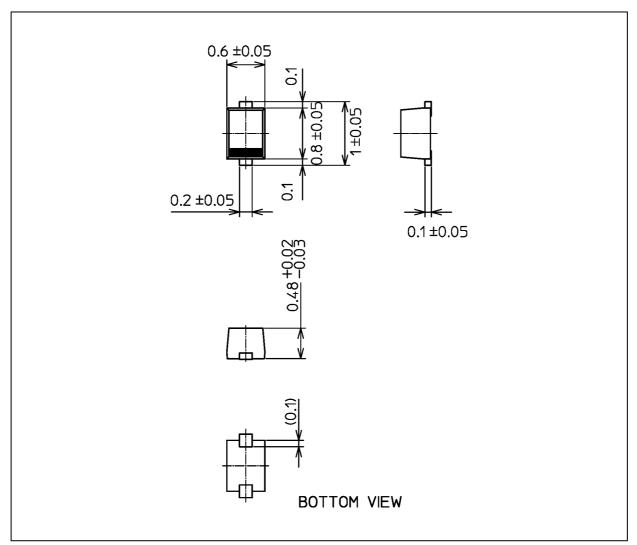
Package Name(s)			
TOSHIBA: 1-1AH1A			
Nickname: SOD-923			



## Package Dimensions

1SS427

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 0.6 mg (typ.)

Package Name(s)
TOSHIBA: 1-1L1S
Nickname: fSC

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